

PATENT ASSIGNMENT

Electronic Version v1.1
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| SUBMISSION TYPE: | NEW ASSIGNMENT | | | | | | | | | | |
|--|--|---------------|----------------|---------------------|------------|------------------|------------|-----------------|------------|-----------------|------------|
| NATURE OF CONVEYANCE: | ASSIGNMENT | | | | | | | | | | |
| CONVEYING PARTY DATA | | | | | | | | | | | |
| <table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Hsin-Chieh Yao</td> <td>05/17/2010</td> </tr> <tr> <td>Hsien-Cheng Wang</td> <td>05/19/2010</td> </tr> <tr> <td>Huang Chien Kai</td> <td>05/17/2010</td> </tr> <tr> <td>Chun-Kuang Chen</td> <td>05/19/2010</td> </tr> </tbody> </table> | | Name | Execution Date | Hsin-Chieh Yao | 05/17/2010 | Hsien-Cheng Wang | 05/19/2010 | Huang Chien Kai | 05/17/2010 | Chun-Kuang Chen | 05/19/2010 |
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| Hsin-Chieh Yao | 05/17/2010 | | | | | | | | | | |
| Hsien-Cheng Wang | 05/19/2010 | | | | | | | | | | |
| Huang Chien Kai | 05/17/2010 | | | | | | | | | | |
| Chun-Kuang Chen | 05/19/2010 | | | | | | | | | | |
| RECEIVING PARTY DATA | | | | | | | | | | | |
| Name: | Taiwan Semiconductor Manufacturing Company, Ltd. | | | | | | | | | | |
| Street Address: | No. 8, Li-Hsin Road 6 | | | | | | | | | | |
| City: | Hsin-Chu | | | | | | | | | | |
| State/Country: | TAIWAN | | | | | | | | | | |
| Postal Code: | 300-77 | | | | | | | | | | |
| PROPERTY NUMBERS Total: 1 | | | | | | | | | | | |
| <table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>12784851</td> </tr> </tbody> </table> | | Property Type | Number | Application Number: | 12784851 | | | | | | |
| Property Type | Number | | | | | | | | | | |
| Application Number: | 12784851 | | | | | | | | | | |
| CORRESPONDENCE DATA | | | | | | | | | | | |
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| ATTORNEY DOCKET NUMBER: | 24061.1449 | | | | | | | | | | |
| NAME OF SUBMITTER: | Rachel L.I. Davis | | | | | | | | | | |
| Total Attachments: 3 | | | | | | | | | | | |

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**PATENT
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Docket No.: 2010-0100 / 24061.1449

Customer No.: 42717

ASSIGNMENT

WHEREAS, we,

- | | | | |
|-----|------------------|----|--|
| (1) | Hsin-Chieh Yao | of | No. 1, Lane 57, Minli Street Yunlin County 640, Taiwan, R.O.C. |
| (2) | Hsien-Cheng Wang | of | 13F-1, No. 373, Sec. 2, Gong-Dao 5 Road Hsinchu 300, Taiwan, R.O.C. |
| (3) | Huang Chien Kai | of | 8F-2, No. 23, Sec. 1, Jiafeng 11th Road Zhubei City, Hsinchu County 302, Taiwan, R.O.C. |
| (4) | Chun-Kuang Chen | of | No. 122, Yu-Hsien Street, Guan-Shi Jeng Hsin-Chu Hsien, Taiwan, R.O.C. |

have invented certain improvements in

OVERLAY MARK ASSISTANT FEATURE

for which we have executed an application for Letters Patent of the United States of America,

 X of even date filed herewith; and
 filed on May 21, 2010 and
 assigned application number 12/784,581; and

WHEREAS, we authorize the attorney of record to update this document to include Patent Office information as deemed necessary (i.e., filing date, serial number, etc.);

WHEREAS, Taiwan Semiconductor Manufacturing Company, Ltd., ("TSMC"), No. 8, Li-Hsin Rd. 6, Science-Based Industrial Park Hsin-Chu, Taiwan 300-77, Republic of China, is desirous of obtaining the entire right, title, and interest in, to and under the said invention and the said application in the United States of America and in any and all countries foreign thereto;

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, and other good and valuable consideration, we have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said TSMC, its successors, legal representatives, and assigns, the entire right, title, and interest in, to and under the said invention, and the said application, and all divisional, renewal, substitutional, and continuing applications thereof, and all Letters Patent of the United States of America which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may be filed for said invention in any country or countries foreign to the United States of America, and all extensions, renewals, and reissues thereof, and all prior patents and patent applications from which a filing priority of the above-described patent application may be obtained, including the right to collect past damages; and we hereby authorize and request the Commissioner of Patents of the United States of America, and any official of any country or countries foreign to the United States of America, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said TSMC, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

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AND WE HEREBY covenant that we have full right to convey the entire interest herein assigned, and that we have not executed, and will not execute, any agreement in conflict herewith.

AND WE HEREBY further covenant and agree that we will communicate to said TSMC, its successors, legal representatives and assigns, any facts known to us respecting said invention, and testify in any legal proceedings, sign all lawful papers, execute all divisional, renewal, substitutional, continuing, and reissue applications, make all rightful declarations and/or oaths and generally do everything possible to aid the said TSMC, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

Inventor Name: Hsin-Chieh Yao

Residence Address: No. 1, Lane 57, Minli Street Townshipshan District
Yunlin County 640, Taiwan, R.O.C.

Dated: 2010.05.17

Hsin-Chieh Yao
Inventor Signature

Inventor Name: Hsien-Cheng Wang

Residence Address: 13F-1, No. 373, Sec. 2, Gong-Dao 5 Road
Hsinchu 300, Taiwan, R.O.C.

Dated: May 19, 2010

Hsien-Cheng Wang
Inventor Signature

Inventor Name: Huang Chien Kai

Residence Address: 8F-2, No. 23, Sec. 1, Jiafeng 11th Road
Zhubei City, Hsinchu County 302, Taiwan, R.O.C.

Dated: Huang Chien kai
2010.05.17

Huang Chien kai
Inventor Signature

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Inventor Name: Chun-Kuang Chen

Residence Address: No. 122, Yu-Hsien Street, Guan-Shi Jeng
Hsin-Chu Hsien, Taiwan, R.O.C.

Dated: 2010.5.19

Chun-Kuang Chen

Inventor Signature